



SBB2089Z

50MHz to 850MHz Cascadable Amplifier

Product Overview

The SBB2089Z is a high performance InGaP HBT MMIC amplifier utilizing a Darlington configuration with an active bias network. The active bias network provides stable current over temperature and process Beta variations. Designed to run directly from a 5V supply, the SBB2089Z does not require a dropping resistor as compared to typical Darlington amplifiers. The SBB2089Z product is designed for high linearity 5V gain block applications that require small size and minimal external components. It is internally matched to 50Ω.

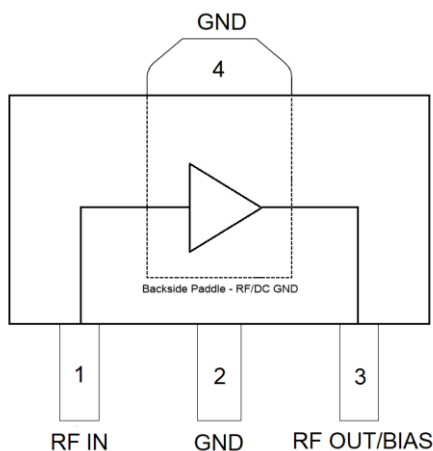


3-pin SOT-89 Package

Key Features

- 50MHz – 850MHz Operational Frequency
- OIP3 = +42.8dBm at 240MHz
- P1dB = +20.8dBm at 500MHz
- Single Fixed 5V Supply
- Robust 2000V ESD, Class 2
- Patented Thermal Design and Bias Circuit
- Low Thermal Resistance

Functional Block Diagram



Top View

Applications

- Receiver IF Amplifier
- Cellular, PCS, GSM, UMTS
- Wireless Data, Satellite Terminals

Ordering Information

Part No.	Description
SBB2089Z	7" Reel with 1000 pieces
SBB2089ZPCK1	50MHz to 850MHz PCBA with 5-piece sample bag

Absolute Maximum Ratings

Parameter	Rating
Storage Temperature	-55 to 150 °C
RF Input Power, CW, 50 Ω, T=+25 °C	+24 dBm
Device Voltage (V _{CC})	+5.5 V
Device Current (I _{CC})	110 mA
Power Dissipation	0.61 W
Junction Temperature (T _J)	+150 °C

Exceeding any one or a combination of the Absolute Maximum Rating conditions may cause permanent damage to the device.

Recommended Operating Conditions

Parameter	Min	Typ	Max	Units
Device Voltage (V _{CC})		+5	+5.3	V
T _{CASE}	-40		+85	°C

Electrical specifications are measured at specified test conditions. Specifications are not guaranteed over all recommended operating conditions. Application of conditions to the device outside the Recommended Operating Conditions may reduce device reliability and performance.

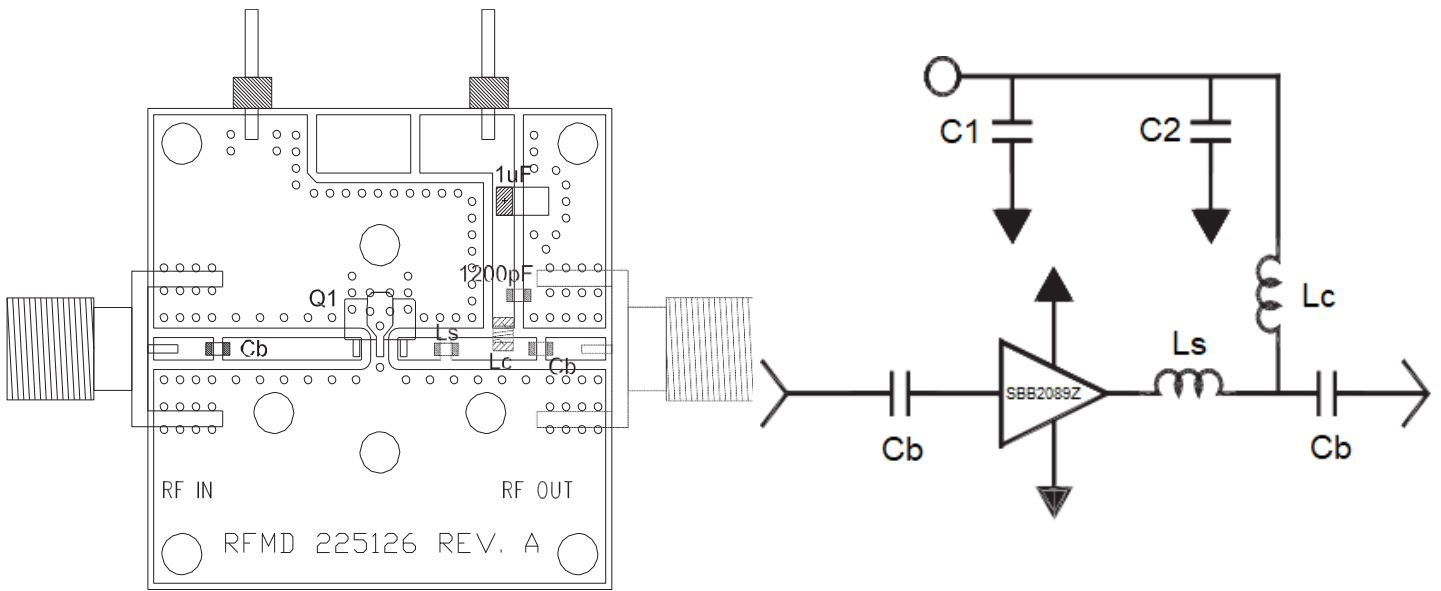
Electrical Specifications

Parameter	Conditions ⁽¹⁾	Min	Typ	Max	Units
Operational Frequency Range		50		850	MHz
Gain	70MHz		20		dB
	240MHz	18.5	20	21.5	dB
	400MHz	18.5	20	21.5	dB
Input Return Loss	70MHz to 5000MHz	15	20		dB
Output Return Loss	70MHz to 5000MHz	11	14		dB
Output P1dB	70MHz		+20		dBm
	240MHz		+20		dBm
	400MHz	+18.5	+21		dBm
Output IP3	P _{out} = 0 dBm/tone, Δf = 1 MHz, Center Freq.= 70MHz		+41		dBm
	P _{out} = 0 dBm/tone, Δf = 1 MHz, Center Freq.= 240MHz		+43		dBm
	P _{out} = 0 dBm/tone, Δf = 1 MHz, Center Freq.= 400MHz	+39	+41		dBm
Noise Figure	500MHz		2.7	3.7	dB
Reverse Isolation	70MHz to 5000MHz		22		dB
Device Operating Current			90	98	mA
Thermal Resistance, θ _{JC}	Junction to case		48.8		°C/W

Notes:

1. Test conditions unless otherwise noted: V_{CC} = +5.0 V, I_{CC} = 90mA, Temp= +25 °C, 50 Ω system.

Evaluation Board



Bill of Material

Reference Des.	Value	Description	Manuf.	Part Number
n/a	n/a	Printed Circuit Board	Qorvo	
Q1	n/a	Cascadable Amplifier	Qorvo	SBB2089Z
Cb	8200 pF	CAP, 0603, 10%, 50V, X7R	various	
C1	1 uF	CAP, 1206, 20%, 20V, TANT-A	various	
C2	1200 pF	CAP, 0603, 10%, 50V, X7R	various	
Ls	2.7 nH	IND, 0603, +/-0.3nH	Murata	LL1608-FSL2N7S
Lc	1.2 uH	IND, 1008, 5%	Coilcraft	1008LS-122XJLC

Typical Performance

Test conditions unless otherwise noted: $V_{CC} = +5.0\text{ V}$, $I_{CC} = 90\text{ mA}$, $\text{Temp} = +25^\circ\text{C}$, $50\ \Omega$ system.

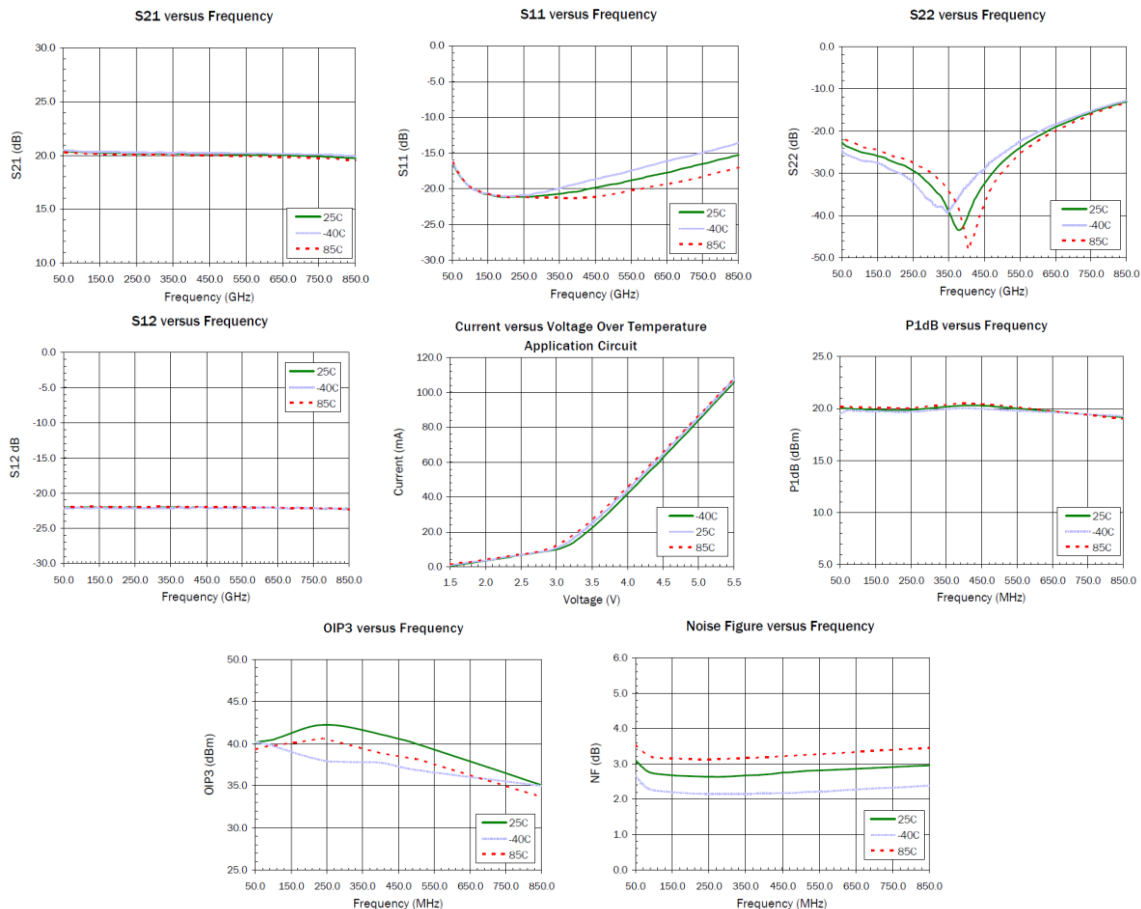
Parameter	Typical Value							Units
Frequency	50	70	100	240	400	500	850	MHz
Gain	20	20	20	20	20	20	20	dB
Input Return Loss	15	18	19	20	20	19	16	dB
Output Return Loss	21	23	24	27	34	30	14	dB
Reverse Isolation	22	22	22	22	22	22	22	dB
Output P1dB	+20	+20	+20	+20	+20	+20	+19	dBm
OIP3 ⁽¹⁾	+40	+40	+41	+42	+41	+40	+35	dBm
Noise Figure	3.1	2.9	2.7	2.6	2.7	2.8	2.9	dB

Notes:

1. $P_{out} = 0\text{ dBm/tone}$, $\Delta f = 1\text{ MHz}$

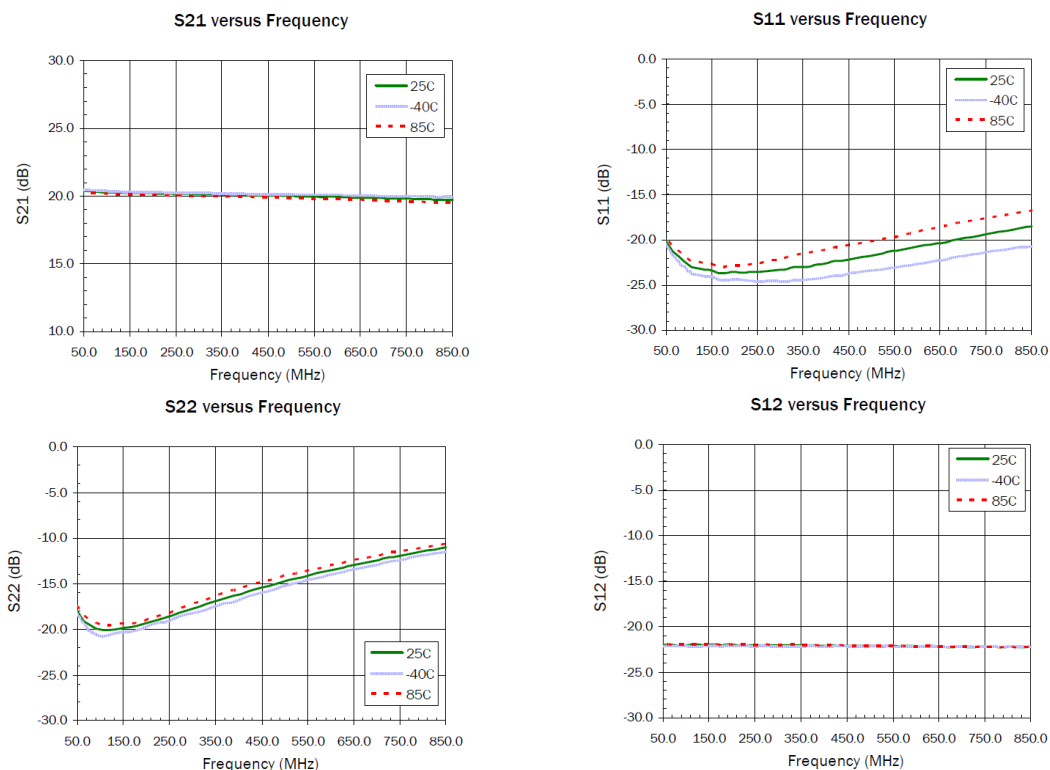
Performance Plots

Test conditions unless otherwise noted: $V_{CC} = +5.0\text{ V}$, $I_{CC} = 90\text{ mA}$, $\text{Temp} = +25^\circ\text{C}$, $50\ \Omega$ system.

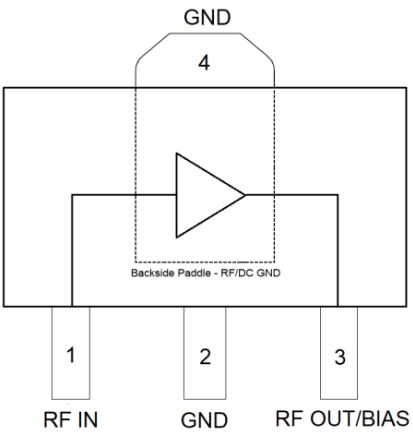


Performance Plots – with BIAS Tees

Test conditions unless otherwise noted: $V_{CC} = +5.0V$, $I_{CC} = 90mA$, Temp = $+25^{\circ}C$, 50Ω system.



Pin Configuration and Description



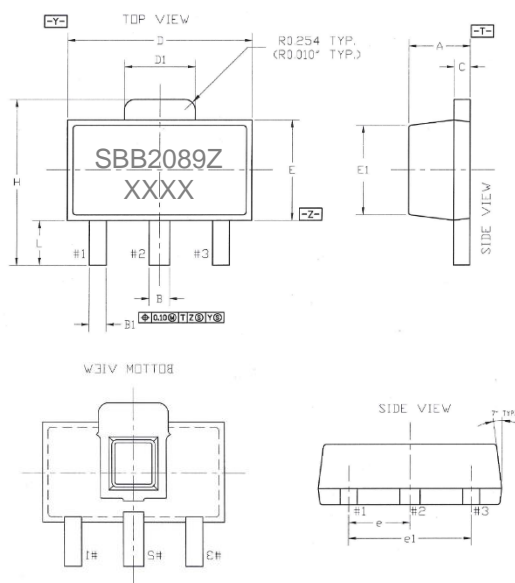
Pin No.	Label	Description
1	RF IN	RF input. External DC Block capacitor required.
2, 4	GND	RF/DC ground. Use recommended via hole pattern to minimize inductance and thermal resistance. See PCB Mounting Pattern for suggested footprint.
3	RF OUT / BIAS	RF output and DC Supply input. External DC Block capacitor and bias voltage required.

Package Marking and Dimensions Outline A

Package Marking

Product ID: SBB2089Z

Trace Code: XXXX



SYMBOL	Common					
	DIMENSIONS MILLIMETER			DIMENSIONS INCH		
	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
A	1.40	1.50	1.60	0.055	0.059	0.063
B	0.44	0.50	0.56	0.017	0.020	0.022
B1	0.36	0.42	0.48	0.014	0.017	0.019
C	0.35	0.40	0.44	0.014	0.016	0.017
D	4.40	4.50	4.60	0.173	0.177	0.181
D1	1.62	1.73	1.83	0.064	0.068	0.072
E	2.30	2.50	2.60	0.091	0.098	0.102
E1	2.13	2.20	2.29	0.084	0.087	0.090
e	1.50 BSC.			0.059 BSC.		
e1	3.00 BSC.			0.118 BSC.		
H	3.95	4.10	4.25	0.156	0.161	0.167
L	0.90	1.10	1.20	0.035	0.043	0.047

NOTES :

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982
2. CONTROLLING DIMENSION : MILLIMETER CONVERTED INCH ARE NOT NECESSARILY EXACT.
3. DIMENSION B1, 2 PLACES.

Notes:

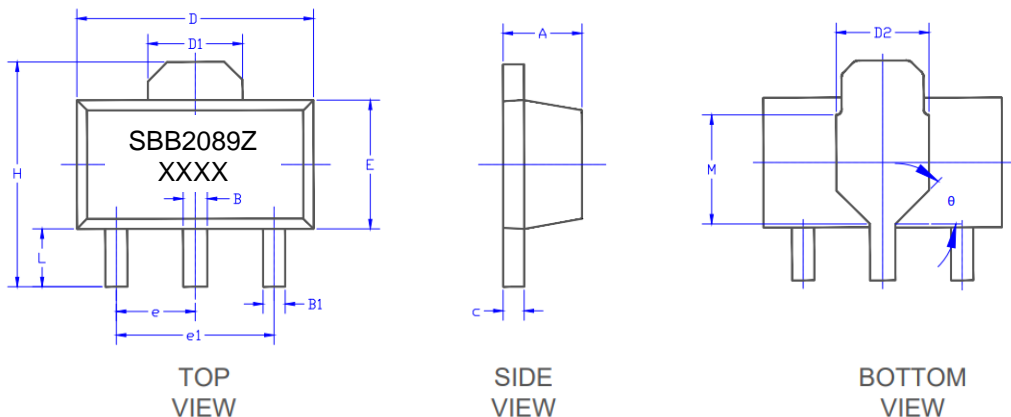
1. All dimensions are in millimeters. Angles are in degrees.
2. Dimension and tolerance formats conform to ASME Y14.4M-1994.
3. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
4. Trace code up to 4 characters to be assigned by sub-contractor.
5. Contact plating: NiPdAu
6. Either package dimensions outline A or B may be supplied.
7. This package outline is shipped as MSL5A.

Package Marking and Dimensions Outline B

Package Marking

Product ID: SBB2089Z

Trace Code: XXXX

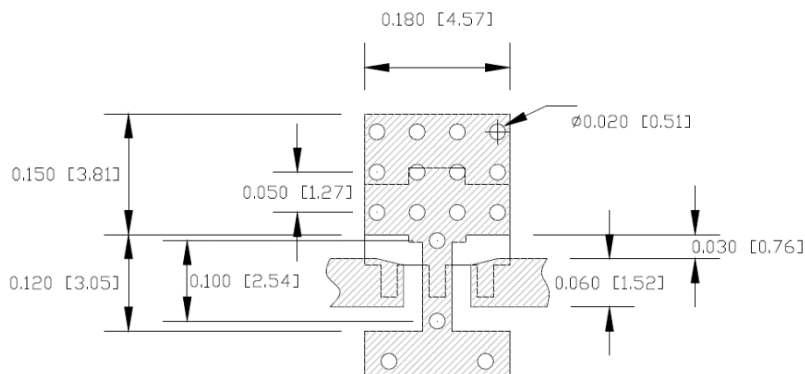


Symbol	Dimensions in Millimeters	
	Min.	Max.
A	1.400	1.600
B	0.400	0.580
B1	0.320	0.520
C	0.350	0.440
D	4.400	4.600
D1	1.550 REF.	
D2	1.600 REF.	
E	2.300	2.600
e	1.500 TYP.	
e1	3.000 TYP.	
H	3.940	4.250
L	0.900	1.200
M	1.900 REF.	
θ	45°	

Notes:

1. All dimensions are in millimeters. Angles are in degrees.
2. Dimension and tolerance formats conform to ASME Y14.4M-1994.
3. The terminal #1 identifier and terminal numbering conform to JESD 95-1 SPP-012.
4. Trace code up to 4 characters to be assigned by sub-contractor.
5. Contact plating: Matte Sn
6. Either package dimensions outline A or B may be supplied.
7. This package outline is shipped as MSL3.

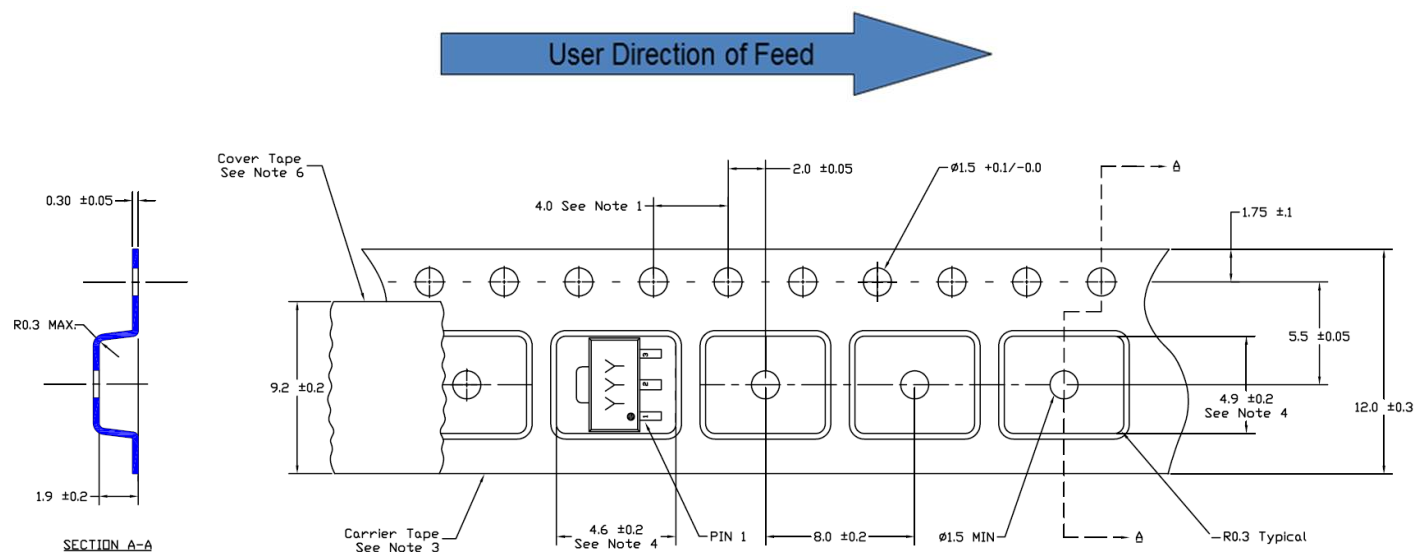
PCB Mounting Pattern



Notes:

1. All dimensions are in millimeters [inches]. Angles are in degrees.
2. Use 1 oz. copper minimum for top and bottom layer metal.
3. Vias are required under the backside paddle of this device for proper RF/DC grounding and thermal dissipation.
4. Do not remove or minimize via hole structure in the PCB. Thermal and RF grounding is critical.
5. We recommend a 0.35mm (#80/.0135") diameter bit for drilling via holes and a final plated thru diameter of 0.25mm (0.01").
6. Ensure good package backside paddle solder attach for reliable operation and best electrical performance.

Tape and Reel Information – Carrier and Cover Tape Dimensions

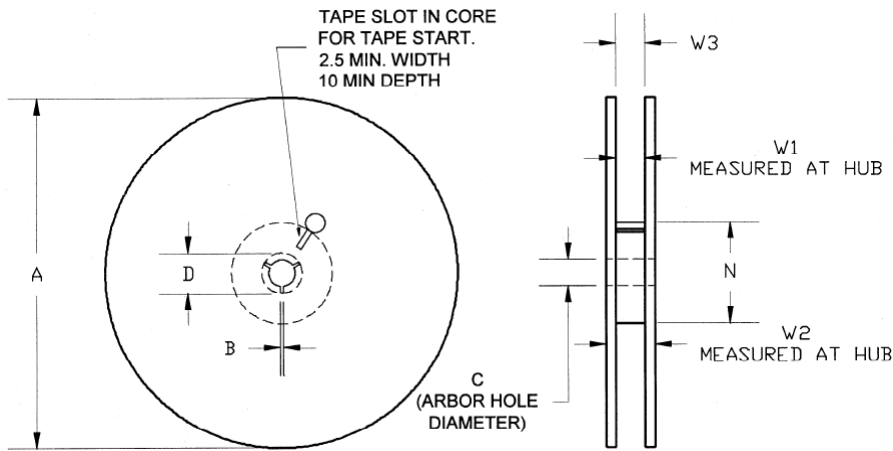


1. 10 sprocket hole pitch cumulative tolerance
2. Camber not to exceed 1mm in 100mm
3. Material: Black Conductive Polystyrene
4. Measured on a plane 0.3mm above the bottom of the pocket.
5. Measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Material: Antistatic Polyester Film

Feature	Measure	Symbol	Size (in)	Size (mm)
Cavity	Length	A0	0.181	4.60
	Width	B0	0.193	4.90
	Depth	K0	0.075	1.90
	Pitch	P1	0.315	8.00
Centerline Distance	Cavity to Perforation - Length Direction	P2	0.079	2.00
	Cavity to Perforation - Width Direction	F	0.217	5.50
Cover Tape	Width	C	0.362	9.20
Carrier Tape	Width	W	0.472	12.0

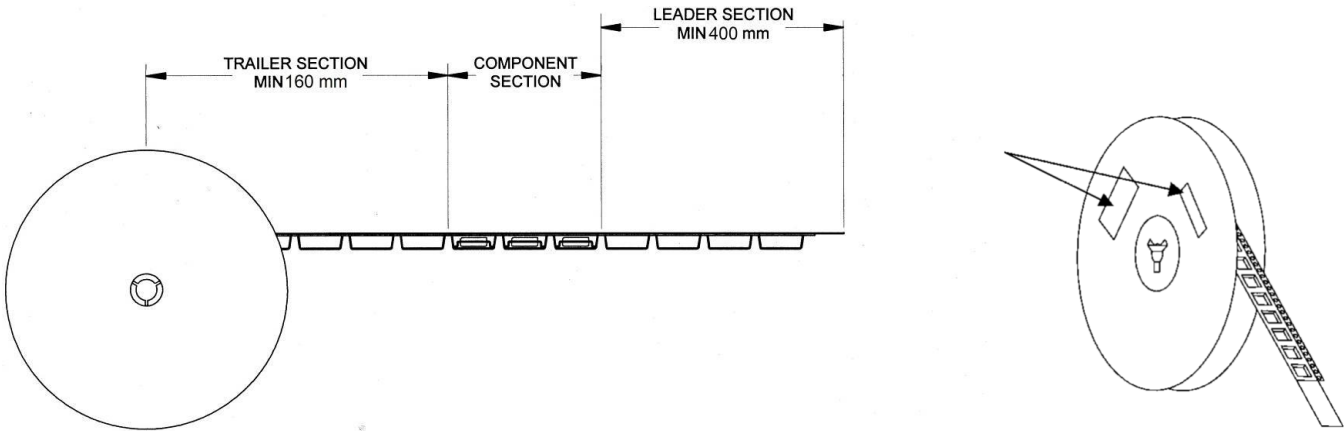
Tape and Reel Information – Reel Dimensions

Standard T/R size = 1,000 pieces on a 7" reel.



Feature	Measure	Symbol	Size (in)	Size (mm)
Flange	Diameter	A	6.969	177.0
	Thickness	W2	0.717	18.2
	Space Between Flange	W1	0.504	12.8
Hub	Outer Diameter	N	2.283	58.0
	Arbor Hole Diameter	C	0.512	13.0
	Key Slit Width	B	0.079	2.0
	Key Slit Diameter	D	0.787	20.0

Tape and Reel Information – Tape Length and Label Placement



- Notes:
1. Empty part cavities at the trailing and leading ends are sealed with cover tape. See EIA 481-1-A.
 2. Labels are placed on the flange opposite the sprockets in the carrier tape.

Handling Precautions

Parameter	Rating	Standard
ESD – Human Body Model (HBM)	Class 2	ESDA / JEDEC JESDC22-A114
MSL – Moisture Sensitivity Level	See Package Dimensions Outline	IPC/JEDEC J-STD-020



Caution!
ESD-Sensitive Device

Solderability

Compatible with the latest version of J-STD-020, lead-free (260°C max. reflow temp.) soldering processes. Solder profiles available upon request.

RoHS Compliance

This part is compliant with 2011/65/EU RoHS directive (Restrictions on the Use of Certain Hazardous Substances in Electrical and Electronic Equipment) as amended by Directive 2015/863/EU.

This product also has the following attributes:

- Lead Free
- Halogen Free (Chlorine, Bromine)
- Antimony Free
- TBBP-A (C₁₅H₁₂Br₄O₂) Free
- PFOS Free
- SVHC Free

Contact Information

For the latest specifications, additional product information, worldwide sales and distribution locations:

Web: www.qorvo.com

Tel: 1-844-890-8163

Email: customer.support@qorvo.com

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